

### MF72-SCN30D-15

#### **Features**

♦ RoHS & Halogen Free (HF) compliant

Body size: Φ15mm

Silicone resin

High power rating

Wide resistance range

Cost effective

◆ Operating temperature range: -40~+200°C

Agency recognition: UL /cUL/RoHS

Package color: green

### **Recommended Applications**

Switch mode power supply

◆ Electric motor

◆ Transformer

◆ Adapter

Projector

Halogen lamp

◆ LED driver circuit

#### Welding and conditions of use

The welding temperature is less than 360 degrees, the distance from the main body is at least 2mm, Time should be as short as possible

 When cutting the lead, pay attention to the shortest lead is 6mm



### **Storage Conditions of Products**

Storage Conditions:

Storage Temperature: -10  $^{\circ}$ C ~ +40  $^{\circ}$ C.

Storage humidity: ≤ 75%RH.

Keep away from corrosive atmosphere and sunlight.

Keep sealed after use.

#### **Part Number Code**

 $\frac{\text{MF72}}{\text{(1)}} - \frac{\text{SCN}}{\text{(2)}} - \frac{30D}{\text{(3)}} - \frac{15}{\text{(4)}}$ 

(1) MF72: MF72 Series.

(2) SCN: Socay NTC.

(3) 30D: Zero Power Resistance at  $25^{\circ}C(R_{25})$ :  $30=30\Omega$ .

(4) Body Size: 15=Φ15mm.

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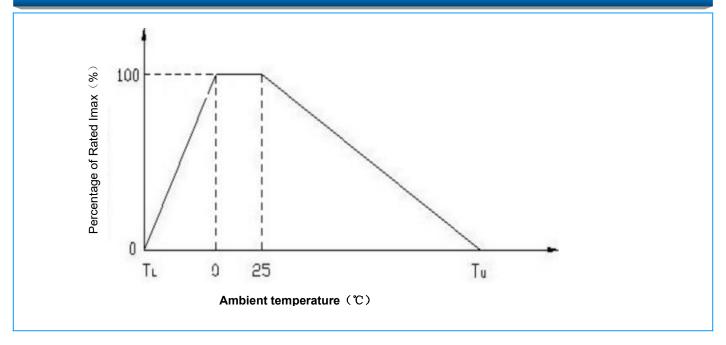


## MF72-SCN30D-15

### **Electrical Characteristics**

Part Number	Resistance at 25℃ ±20%	Max. Permissible Working Current	Resistance under Load (mΩ)	Dissipation Factor	Thermal Time Constant	Maximum permissible capacitance @240Vac
	R <sub>25</sub> (Ω)	I <sub>max</sub> (A)	(mΩ)	δ(mW/℃)	τ(Sec.)	C(uF)
MF72-SCN30D-15	30	3.5	438	21	75	470

## **Maximum Current Derating (I/Imax)**



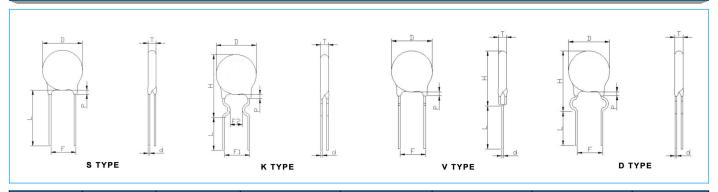
Remarks :  $T_{L=lowest\ temperature\ (c)}$ 

 $T_{U=Maximum\ temperature\ ({\mathfrak C})}$ 



## MF72-SCN30D-15

## Structure and Dimensions (Unit: mm)



D max	T max	P max	F	H max	L	đ	Туре
16.5	5.5	3.5	7.5±1.0	23.0	Min17.0	0.8±0.05	S/K/V/D

Note: Length of Pin (L) can be customized.

## **Packing Specifiction**

Part Number	Туре	Quantity (pcs/bag)
MF72-SCN30D-15	S/K/V/D	250

### **Electrical performance**

ltem	Standard test	Definition and test method		
Zero power resistance R <sub>25</sub> =30Ω±20%		Zero load resistance at 25 $^\circ\!$		
Maximum steady state current	I <sub>max</sub> =3.5A	Maximum continuous current allowed to be applied to the resistor at 25°C		
Maximum rate of change of resistance value capacity  At △R/R≤±20%, and No damage to appearance		Apply maximum capacitance, intermittent closing 50Ms, recovery time stimes, 500 cycles		
B value B25/50=2880±10%		B value between 25°C and 50°C B=Ln(R1/R2)/(1/T1-1/T2) T1 = (273.15 + 25) K T2 = (273.15 + 50) K Note: 273.15 is absolute temperature		
Thermal time constant ≈75seconds		Under zero power conditions, in still air, the time required for the temperature of the thermistor to drop to 63.2% of the difference between its initial temperature and the final temperature.		
Heat dissipation coefficient δ≈21mW/°C		The power required to increase the temperature of the thermistor by 1°C in still air at 25°C		
residual resistance 0.438Ω		Pass maximum steady state current and reach steady state resistance value		
Insulation resistance	≥100MΩ	Press 500VDC at room temperature for 60sec		
Operating temperature range T <sub>w</sub> =-40°C∼+170°C		Temperature range under specified use conditions		

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## MF72-SCN30D-15

## Reliability

NO	Item	Standard	Test method	Technology requirement
1	Solderability	IEC60068-2-20 (GB2423.28)	Dip the terminal with flux, and immerse it in a tin bath with a temperature of 235 $\pm$ 5°C, and the tin surface is 2 $\sim$ 2.5mm away from the lower end of the NTC body for 2 $\pm$ 0.5S. Check the appearance after the test	The solder on the terminal end flows freely and well wetted, and the upper tin area is more than 95%.
2	Resistance to welding heat	IEC60068-2-20 (GB2423.28)	Dip the terminal with flux and immerse it in a tin bath at a temperature of 260 $\pm$ 5°C, the tin surface is at least 6mm away from the bottom of the NTC body, duration: 10 $\pm$ 1S. After the test is completed, after recovering 1 $\sim$ 2Hr under normal temperature and humidity, check the appearance and retest R25 rated zero power resistance	No visible damage in appearance △R/R25≤±25%
3	Terminal strength	IEC60068-2-21 (GB2423.29)	Test 1: Tensile force 10N, continuous 10S. Test 2: Bend at 90° for two consecutive times, with a tensile force of 5N, and lasting for 10S: After the test is completed, after recovering 1 $\sim$ 2Hr under normal temperature and humidity, Check the appearance and retest R25 rated zero power resistance	No visible damage in appearance △R/R25≤±25%
4	High temperature test	IEC60068-2-2 (GB2423.2)	Environment temperature: 120°C±5°C  Duration: 1000±24h  After the test is completed, after recovering 1∼2Hr  under normal temperature and humidity, retest R25  rated zero power resistance	∆R/R25≤±25%
5	Low temperature test	IEC60068-2-1 (GB2423.1)	Environment temperature: -40 ℃±5 ℃  Duration: 1000±24h  After the test is completed, after recovering 1~2Hr under normal temperature and humidity,  Retest R25 rated zero power resistance	∆R/R25≤±25%
6	Room temperature energization test	-	$25\pm5$ °C, energized $1000\pm24$ h, DC0.2mA. Ambient temperature: $40$ °C $\pm2$ °C Ambient humidity: $90\%\sim95\%$	△R/R25≤±25%



## MF72-SCN30D-15

## Reliability (Continue)

NO	Item	Standard	Test method	Technology requirement
7	Humidity resistance test (Steady state damp heat)	IEC60068-2-3 (GB2423.3)	Duration: $1000\pm24h$ After the test is completed, after recovering $1\sim2Hr$ under normal temperature and humidity, Retest R25 rated zero power resistance	∆R/R25≪±25%
8	Thermal shock test	IEC60068-2-14 (GB2423.22)	Low temperature: -30°C±2°C  Low temperature residence time: 3min±0.5min  High temperature: 150°C±5°C  High temperature residence time: 3min±0.5min  High and low temperature conversion time: ≤30S,  repeated 100 times  After the test is completed, after recovering 1~2Hr  under normal temperature and humidity,  Retest R25 rated zero power resistance	∆R/R25≤±25%